

D D 2 D s 3 D G 4

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Power 56

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 5)	234		
	-Continuous	T _C = 100 °C	(Note 5)	148	٨	
	-Continuous	T _A = 25 °C	(Note 1a)	32	Α	
	-Pulsed		(Note 4)	1021		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	937	mJ	
P _D	Power Dissipation $T_{\rm C} = 25^{\circ}$			156	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.7	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

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$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	45	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86550	FDMS86550	Power 56	13 "	12 mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V
ΔBV _{DSS} ΔT.I	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		31		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	acteristics					
		V _{GS} = V _{DS} , I _D = 250 μA	2.5	3.3	4.5	V
V _{GS(th)}	Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$v_{GS} = v_{DS}, i_D = 250 \mu\text{A}$	2.5	3.3	4.0	v
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-12		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 32 A		1.4	1.65	mΩ
	Static Drain to Source On Resistance	V _{GS} = 8 V, I _D = 27 A		1.7	2.2	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 32 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		2.2	2.6	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 32 \text{ A}$		96		S
•	Characteristics			1	1	
C _{iss}	Input Capacitance	V _{DS} = 30 V, V _{GS} = 0 V,		8235	11530	pF
C _{oss}	Output Capacitance	f = 1 MHz		2140	3000	pF
C _{rss}	Reverse Transfer Capacitance			70	120	pF
R _g	Gate Resistance		0.1	0.9	2.7	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			43	69	ns
t _r	Rise Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 32 \text{ A},$		27	43	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		42	67	ns
t _f	Fall Time			11	20	ns
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		110	154	nC
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 8 \text{ V} \text{ V}_{DD} = 30 \text{ V},$		90	126	nC
Q _{gs}	Gate to Source Charge	I _D = 32 A		40		nC
Q _{gd}	Gate to Drain "Miller" Charge			20		nC
Drain-Sou	urce Diode Characteristics					
M	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.7	1.2	- V
V _{SD}	Source to Drain Diode Forward voltage	$V_{GS} = 0 V, I_S = 32 A$ (Note 2)		0.8	1.3	
t _{rr}	Reverse Recovery Time	— I _F = 32 A, di/dt = 100 A/μs		68	109	ns
Q _{rr}	Reverse Recovery Charge	$F = 52 A, d/dt = 100 A/\mu s$		62	99	nC



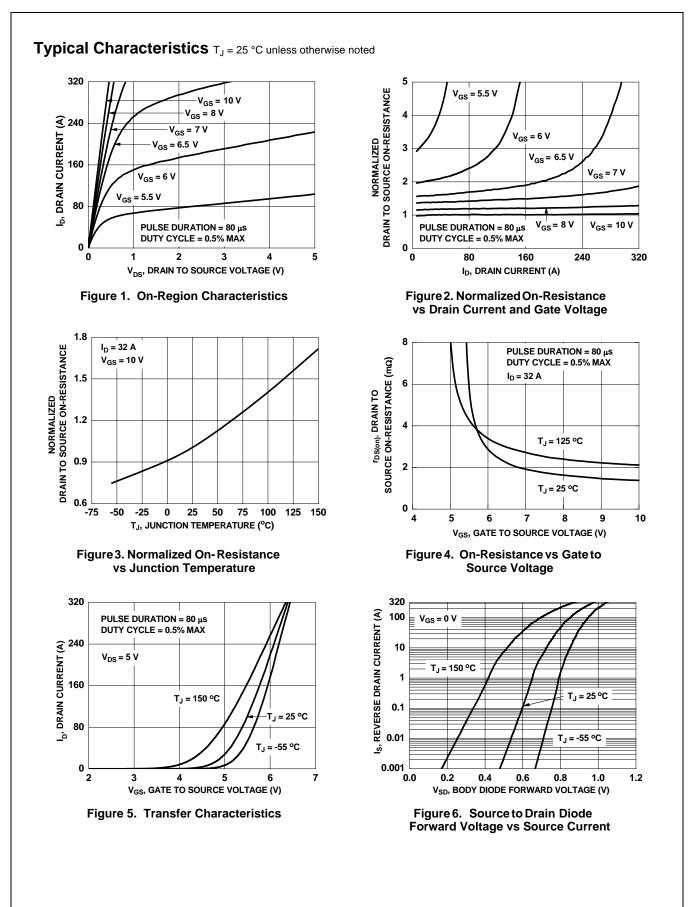


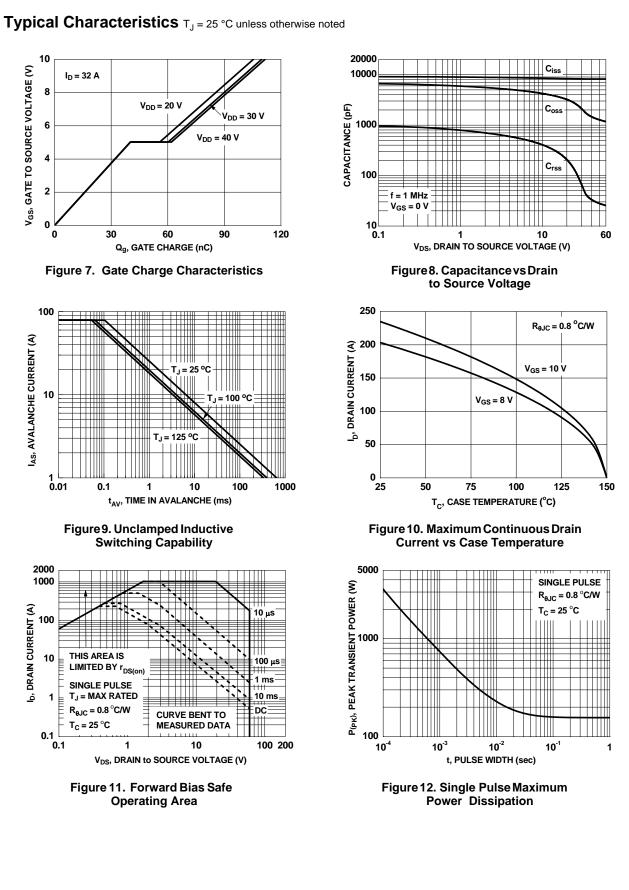
3. E_{AS} of 937 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 25 A, V_{DD} = 60 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 79 A.

4. Pulsed Id please refer to Fig 11 SOA graph for more details.

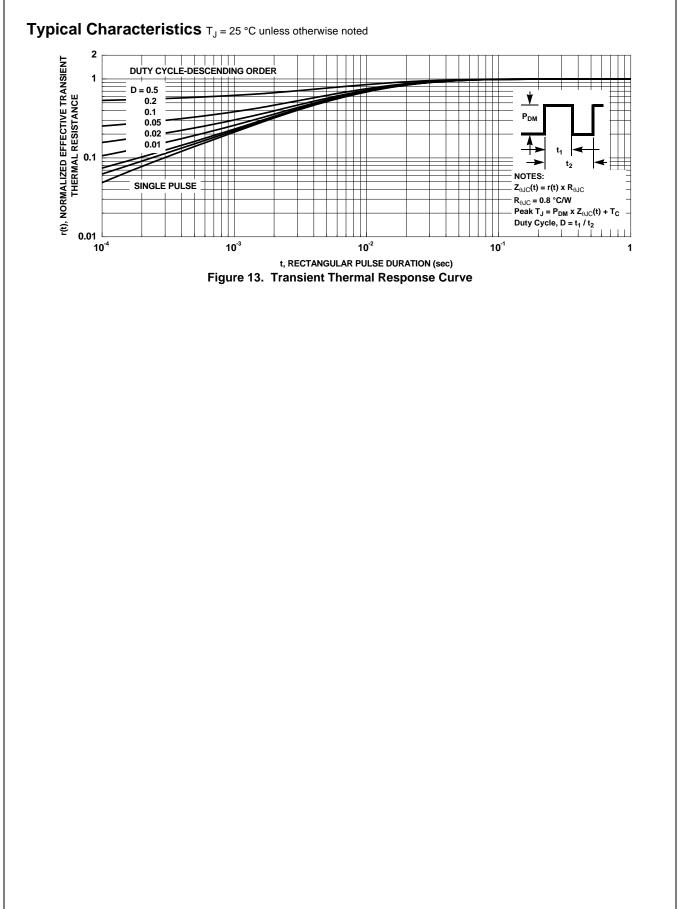
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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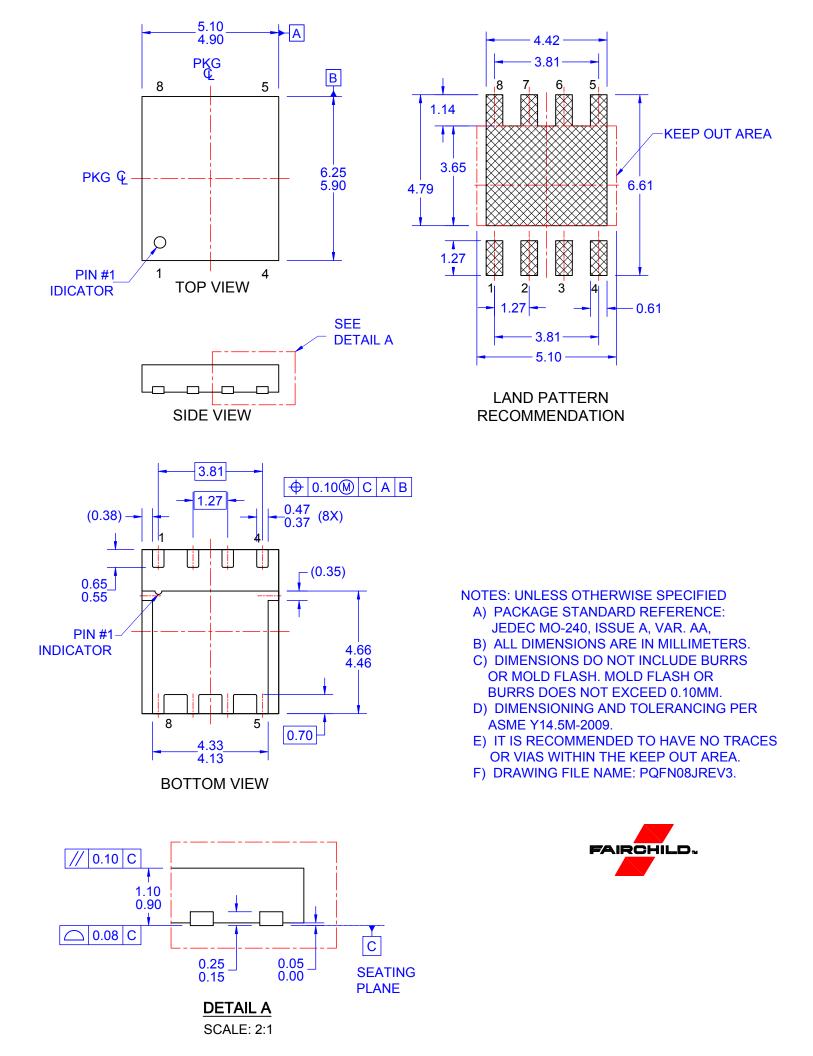




FDMS86550 N-Channel PowerTrench[®] MOSFET



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